



Atty. Docket No. AMAT/4582/ISM/COPPER/IDV

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application Assistant Commissioner of Patents and Trademarks

Washington, D.C. 20231

Re:

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PETER HEY and BYUNG-SUNG LEO KWAK

Inventor(s): Title:

METHOD AND APPARATUS TO OVERCOME ANOMALIES IN COPPER SEED

LAYERS AND TO TUNE FOR FEATURE SIZE AND ASPECT RATIO

Transmitted herewith is the patent application identified above, including:

- <u>x</u> Specification, claims and abstract, totaling 21 pages.
- х Drawings totaling 3 pages, X Formal Informal.
- Executed Declaration and Power of Attorney. Х
 - Information Disclosure Statement w/ Form 1449 and References.
 - Assignment of the invention to Applied Materials, Inc.

Assignment Recordation Cover Sheet

Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	21	-20=	1	x \$18.00	\$ 18.00
Independent Claims	3	-3=	0	x \$80.00	\$ 0.00
Basic Filing Fee \$710.00					\$710.00

- The Commissioner is hereby authorized to charge \$728.00 to Deposit Account No. 50-X 1074/4582/ISM/COPPER/DV.
- The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any X overpayment to Deposit Account No. 50-1074/4582/ISM/COPPER/DV. A duplicate copy of this transmittal is enclosed.
- х Please address all future correspondence to:

PATENT COUNSEL APPLIED MATERIALS, INC. Legal Affairs Department

P.O.BOX 450A

Santa Clara, CA. 95052

correspondence is being depo

ipt No. EL684621630US

Robert W. Mulcahy

Registration No. 25,436

(713) 623-4844

Respectfully